The handse t consist s of BML, LCD, RF-Module, Keypad, Regulator, Charger, EEPROM X-tal, Earpiece, Ringer, Microphone and soon.

### 1 . Burs † Mode Logic (BM L)

The BML control all function of the handset, we used the DE56200AA4CLC of DSPG for the BML.

#### The DE56200AA4CLC is controller for DECT only.

This device include all control circuits of the handset for RF module, LCD controller, keypa d interface, earpiece, Microphon e, ADPCM CODEC, switchin g and series regulator and soon. Also, the embedde d processor to be compatible with Intel 8051-cor e process the program.

### 2 . Charger

The base supply DC 7.5V power to the charge r and the charge r charge r the batteries to use this power. The CDT signal on the charge r circuit is generate d when the handset is to being charge dt his signal is used to control the charge r circuit and for automatic off-hook by cradle-of when an incoming call is coming.

### 3 . Switching & Linear Regulator

The switchin Regulator generate s DC 3.3V voltage from the batteries (3. 6V/ 3cell).

The generate d voltag e is supplie d to the C2830 and then the linear regulator generate DC 3.3V voltage . DC 3.3V is used for RF-modul e, DC 3.3V is used for the DE56200AA4CLC and the circumferenc e circuits.

## 4 . EEPROM

This is 32K bytes of non-volatil e memory. The each kind of value to set-up at note-book memory, redial memory, and so on are stored in this device, sms r.

### 5 . LCD

Dots matrix LCD display(128\*64 dots matrix).

### 6 . KEY PAD

The keypad consist s of 12 dialing keys and 8 function keys.

# **RF CIRCUIT DESCRIPTION**

1. RF Module The DE19RF19 (B3) RF IC Transceiver for DECT Standard Applications operating in European, Latin American and North American frequency ranges allocated for DECT.

2. Both the DE19RF19 PIN17-PIN25 and DSPG's base hand can support several receivers to base hand interface.

3. The receiver input circuit uses a balun1 circuitry. This BALUN transforms the single ended 50  $\Omega$  source from the band filter to the DE19RF19 RXP&RXN differential RF input. The parallel inductor (L2.L3) is used to resonate between RXP and RXN inputs and cancel the differential imaginary parallel part of the chip impedance, thus the resultant impedance has only a 'real' component. This RX BALUN is composed of (L2.L3.C15.C5.L7.L9.C4).

4. The transmitting output is symmetrical with an open collector output structure, more suitable for power transmission. Therefore two external collector coils are connected from TXN&TXP (pin 9 and 10) to the supply rail. On this RF module, these coils are made by (L11, L12). The symmetrical signal coming out is transformed to an asymmetrical signal using coupling capacitors (C63, C64) and a BALUN (C11.L4.L5.C24.C27.). The typical output power at this point is 20dBm.

5. After the Rx/Tx PIN diode (D1), The PIN diode is used as a switch, when open it provides 15dB isolation and less than 1dB loss when closed. The control signal *TRSW and TRSWN* from the DE19RF19